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Electronic Patent Application Submission  
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Title of Invention: Encapsulation of Electronic  
Devices with Shaped Spacers  
First Named Inventor: Ewald Guenther  
Domestic/Foreign Application: Domestic Application  
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# TRANSMITTAL

Electronic Version v1.1  
Stylesheet Version v1.1.0

Title of Invention	Encapsulation of Electronic Devices with Shaped Spacers							
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Documents being submitted

us-ids

Files

02P12562US-IDS-2-usidst.xml

us-ids.dtd

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Comments



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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